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functionality for your application.
IEPE sensor interface PLC analog input module

Project Title:

Designed for:

Public Release

Assembly Variant:

001

PCB Number: TIDA-01471

PCB Rev: E2

Variant/Label Table

<table>
<thead>
<tr>
<th>Variant</th>
<th>Label Text</th>
</tr>
</thead>
<tbody>
<tr>
<td>001</td>
<td>Default</td>
</tr>
</tbody>
</table>

PCB Label

Size: 0.65" x 0.20"

Assembly Notes:

- These assemblies are ESD sensitive. ESD precautions shall be observed.
- These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
- These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Assembly Note

ZZ1

This Assembly Note is for PCB labels only

Assembly Note

ZZ2

These assemblies are ESD sensitive, ESD precautions shall be observed.

Assembly Note

ZZ3

These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

Assembly Note

ZZ4

These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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